

# EM-1712

Shipped in packet-tape reel(5000pcs/Reel)

EM-1712 is ultra-small Hall effect ICs of a single silicon chip composed of Hall element and a signal processing IC.

Bipolar Hall Effect Latch Supply Voltage 1.6~5.5V

Power down Function

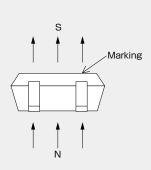
Ultra High Sensitivity Bop: 1.8mT

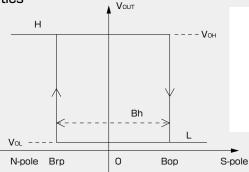
Output **CMOS** 

**SMT** 

Notice: It is requested to read and accept "IMPORTANT NOTICE" written on the back of the front cover of this catalogue.

### Operational Characteristics







### Magnetic flux density

### ● Absolute Maximum Ratings (Ta=25°C)

Item	Symbol	Min.	Max.	Unit
Supply Voltage	V <sub>DD</sub>	-0.1	6.0	V
PDN input voltage	VIN	-0.1	V <sub>DD</sub> +0.1	٧
PDN input current	lin	-10	+10	mA
Output Current	Іоит	-0.5	+0.5	mA
Storage Temperature Range	Тѕтс	-40	+125	°C

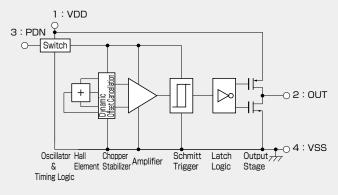
### Recommended Operating Conditions

Item	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage	V <sub>DD</sub>	1.6	3.0	5.5	٧
Operating Temperature Range	Topr	-30	+25	+85	$^{\circ}$

### ■Magnetic ① and Electrical Characteristics (Ta=25°C VDD=3.0V)

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Operating Point *1	Вор			1.8	4.0	mT
Releasing Point *1	Brp		-4.0	-1.8		mT
Hysteresis	Bh			3.6		mT
PDN input High voltage	VIH		0.7V <sub>DD</sub>			V
PDN input Low voltage	VIL				0.3	V
Output High Voltage	Vон	lo=-0.5mA	V <sub>DD</sub> -0.4			V
Output Low Voltage	Vol	Io=+0.5mA			0.4	V
Supply Current1*2	loo1	PDN=L			1	μΑ
Supply Current2*2	loo2	PDN=H,Average		60	150	μΑ
PDN input Current	lin		-1		1	μΑ
PDN mode transition time1*3	Tpd1	Active→PDN			(36.6)	μs
PDN mode transition time2	T <sub>PD</sub> 2	PDN→Active			100	μs
					1 [mT] =1	[Gauss]

### Functional Block Diagram



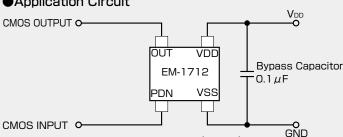
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Pulse Drive Period	Трр3	PDN=H	0.5	1.0	1.5	ms
PDN input Pluse Width	Tw		100			μs
Pulse Drive Time	T <sub>PD</sub> 4	PDN=H	12.2	24.4	36.6	μs

### ■Magnetic Characteristics ② (Ta=-30~+85°C VDD=3.0V)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Operating Point	Вор			1.8	4.2	mT
Releasing Point	Brp		-4.2	-1.8		mT
Hysteresis	Bh			3.6		mT

Note) The above specifications are design targets.

### Application Circuit



- \*1: Positive("+") polarity flux is defined as the magnetic flux from south polewhich is direct toward to the branded face of the sensor (Bop,Brp)
  \*2: In case of PDN pin is held at VDD or GND.
  \*3: This transition time is not guarantee

•Please be aware that our products are not intended for use in life support equipment, devices, or systems. Use of our products in such applications requires the advance written approval of our sales staff.

Certain applications using semiconductor devices may involve potential risks of personal injury, property damage or loss of life. In order to minimize these risks, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards. Inclusion of our products in such applications is understood to be fully at the risk of the customer using our devices or systems.

### Package (Unit:mm) ●(For reference only)Land Pattern (Unit:mm) 0.25 0.50 03 2 φ0.3 2.1±0.2 0~0.1 Sensor center 0.90 25 8 3 0.05 0.1 Sensor çenter Note 1) The sensor center is located within the $\phi$ 0.3mm circle. 0.55 က Note2) The tolerances of dimensions with no mentions is $\pm 0.1$ mm. Note3) Coplanarity: The differences between <u>5°</u> standoff of terminals are max.0.1mm. 1.30 Pin No. Note4) The sensor part is located 0.4mm(typ.) Pin Name | Function far from marking surface. VDD Power Supply OUT Output PDN Power Down

# Function Timing Chart 1 B[mT] S Bop O Brp VPDN [V] VOUT [V] O Undefined TPD2(<100 \( \mu \)s) TPD2(<100 \( \mu \)s) TPD1(<36.6 \( \mu \)s) TPD1(<36.6 \( \mu \)s)

## Note1) During power down mode, output is latched in its previous state.

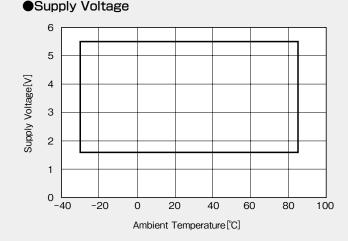
Note2) When VDD is supplied, the time from reaching V<sub>DD</sub>= 1.6V to the update of the output state is equal to T<sub>PD</sub>2.

**Functional Timing** 

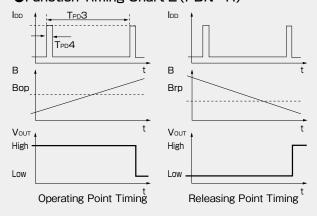
### 1.6V to the update of the o

VSS

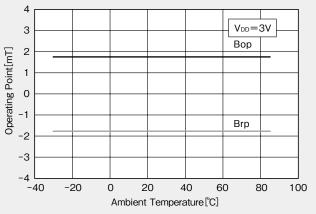
Ground



### ●Function Timing Chart 2(PDN=H)







.

n

0

р

### **IMPORTANT NOTICE**

- These products and their specifications are subject to change without notice. When you consider any use or application of these products, please make inquiries the sales office of Asahi Kasei Microdevices Corporation (AKM) or authorized distributors as to current status of the products.
- Descriptions of external circuits, application circuits, software and other related information contained in this document are provided only to illustrate the operation and application examples of the semiconductor products. You are fully responsible for the incorporation of these external circuits, application circuits, software and other related information in the design of your equipments. AKM assumes no responsibility for any losses incurred by you or third parties arising from the use of these information herein. AKM assumes no liability for infringement of any patent, intellectual property, or other rights in the application or use of such information contained herein.
- Any export of these products, or devices or systems containing them, may require an export license or other official approval under the law and regulations of the country of export pertaining to customs and tariffs, currency exchange, or strategic materials.
- AKM products are neither intended nor authorized for use as critical componentsNote1) in any safety, life support, or other hazard related device or systemNote2), and AKM assumes no responsibility for such use, except for the use approved with the express written consent by Representative Director of AKM. As used here:
  - Note1) A critical component is one whose failure to function or perform may reasonably be expected to result, whether directly or indirectly, in the loss of the safety or effectiveness of the device or system containing it, and which must therefore meet very high standards of performance and reliability. Note2) A hazard related device or system is one designed or intended for life support or maintenance of safety or for applications in medicine, aerospace, nuclear energy, or other fields, in which its failure to function or perform may reasonably be expected to result in loss of life or in significant injury or damage to person or property.
- It is the responsibility of the buyer or distributor of AKM products, who distributes, disposes of, or otherwise places the product with a third party, to notify such third party in advance of the above content and conditions, and the buyer or distributor agrees to assume any and all responsibility and liability for and hold AKM harmless from any and all claims arising from the use of said product in the absence of such notification.